ROHS

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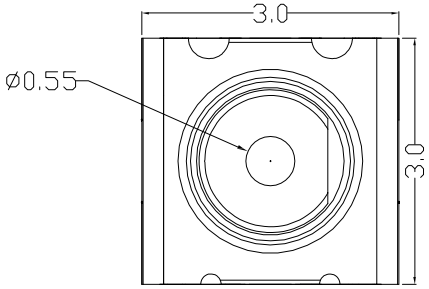
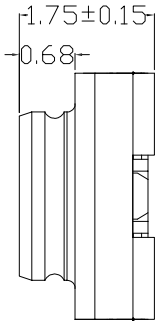
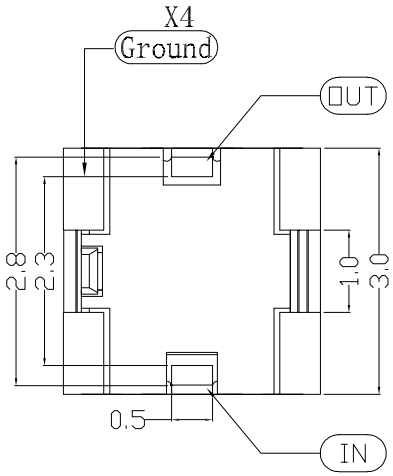
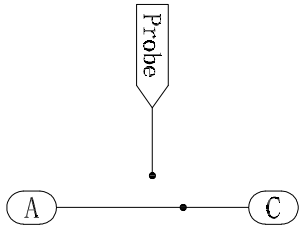
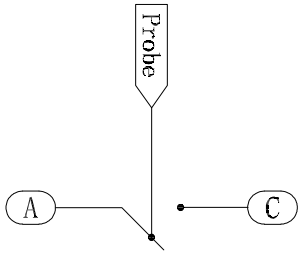




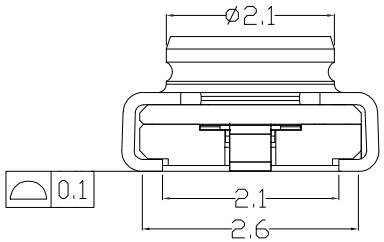


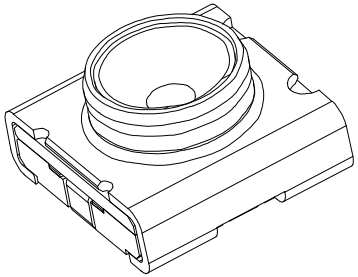


Unmzting

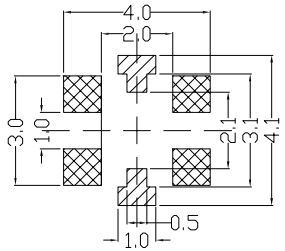


Mating with probe

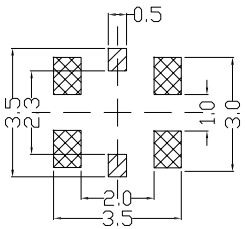




1. Material:
   Contact:High Performance Copper Alloy
   Shielding Cover:High Performance Copper Alloy
   Housing:Engineering Plastic.
2. Finish:
   Contact: 50u″Nickel Underplating Overall.
   Gold Flash 2-3u″ on Contact and Soldertail Area.
   Shielding Cover:50u″ Nickel Underplating Overall.
   Gold Flash min 1u″ on & Soldertails Area.



Recommended PCB Layout



Recommand Stencil Mask Pattern

ECN NO.	REV.	DATE.	DESCRIPTION.	CHANGE.	CHECK.	APPRO.
	A		NEW			

APPROVALS		DATE
DRAWN	ZHIWEI.CHEN	2021.09.07
CHECKED		
APPROVALS		

TOLERANCES ARE			ANGLE
	30~以上	±0.30	±2°
	10~30	±0.20	
	5~10	±0.15	
	~ 5	±0.10	

GEPU歌普

TITLE:	一代带开关天线座		
PART NO.	GP-1A-02-01		
UNIT: mm	SCALE: 1:1	PROJ:	
DRAWING NO.		SHEET 1 OF 1	